### INTRODUCTION

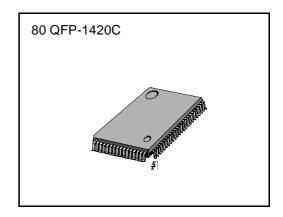
KS0066U is a dot matrix LCD driver & controller LSI whichis fabricated by low power CMOS technology. It can display 1 or 2 lines with the  $5\times8$  dots format or 1 line with the  $5\times11$  dots format.

### **FUNCTIONS**

- · Character type dot matrix LCD driver & controller.
- Internal driver: 16 common and 40 segment signal output.
- Easy interface with 4-bit or 8-bit MPU.
- Display character pattern: 5x8 dots format (208 kinds) & 5x11 dots format (32 kinds).
- The Special character pattern is directly programmable by the Character Generator RAM.
- A customer character pattern is programmable by mask option.
- Programmable Driving Method by the same character font mask option: Display Waveform A-type and B-type
- It can drive a maximum at 80 characters by using the KS0065B or KS0063B externally.
- · Various instruction functions.
- · Built-in automatic power on reset.

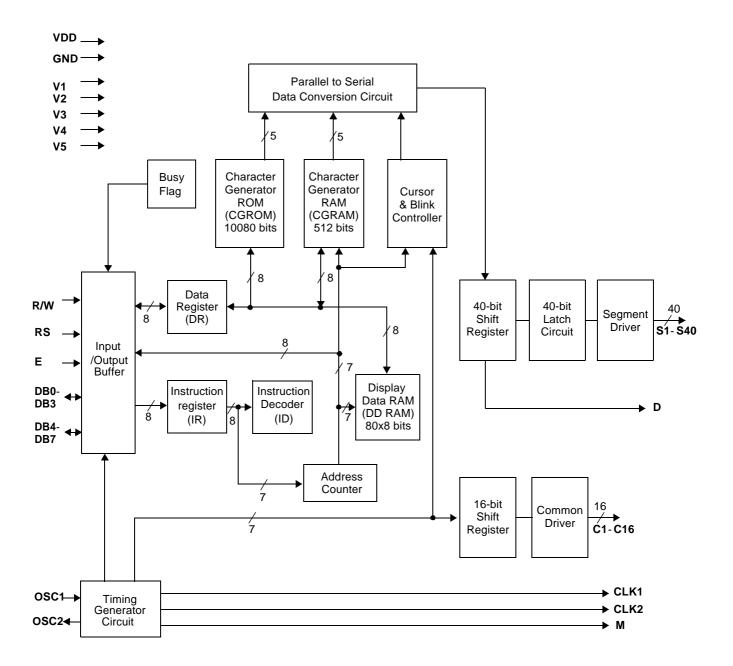
### **FEATURES**

- Internal Memory
  - Character Generator ROM (CGROM): 10,080 bits (204 characters×5×8 dots) & (32 characters×5×11 dots)
  - Character Generator RAM (CGRAM): 64×8 bits (8 characters×5×8 dots)
  - Display Data RAM (DDRAM): 80×8 bits (80 characters max.)
- · Low power operation
  - Power supply voltage range (VDD): 2.7 to 5.5 V
  - LCD Drive voltage range (VDD-V5): 3.0 to 13.0 V
- · CMOS process
- Programmable duty cycle: 1/8, 1/11, 1/16
- · Internal oscillator with external resistor
- · Low power consumption
- 80 QFP or bare chip available

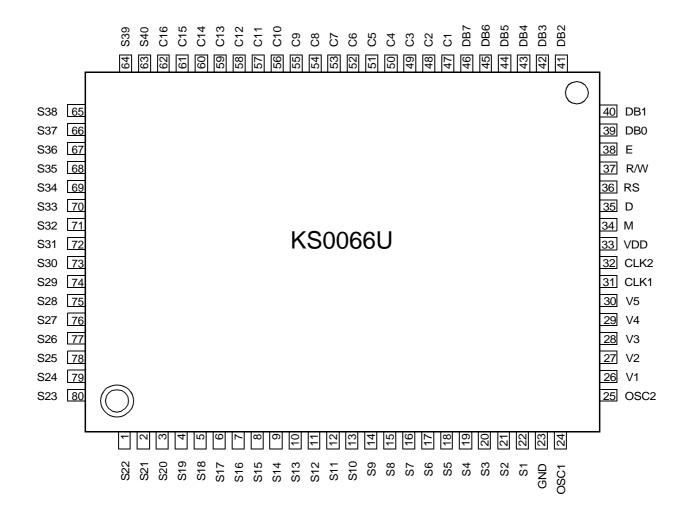




### **BLOCK DIAGRAM**

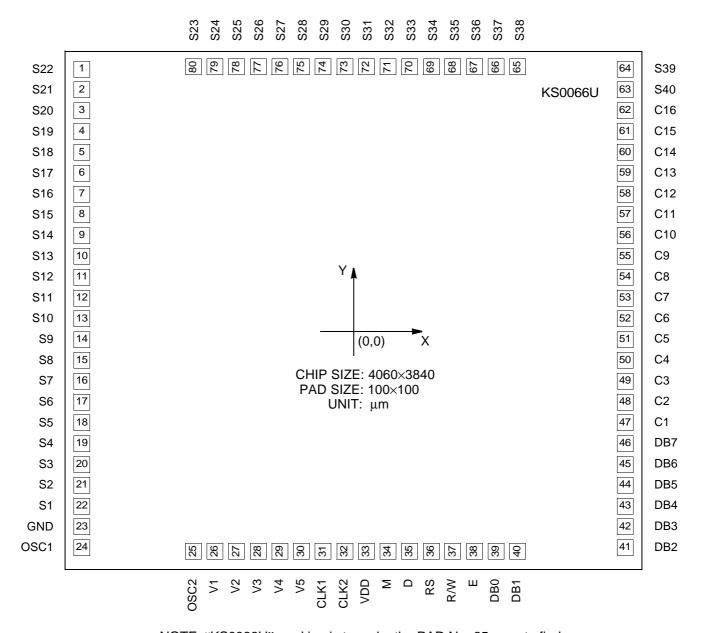


### **PIN CONFIGURATION**





### **PAD DIAGRAM**



NOTE: "KS0066U" marking is to make the PAD No. 65 easy to find.



(Unit: mm)

#### PAD LOCATION

**Table 1. Pad Location** 

Coordinate Coordinate Coordinate Coordinate Pad Pad Pad Pad Pad Pad Pad Pad No. Name Name Name No. No. Name No. Χ Χ Χ S22 1 -1864 1465 21 S2 -1864 -1034 41 DB2 1864 -1488 61 C15 1864 1085 2 S21 -1864 1340 22 S1 -1864 -1159 42 DB3 1864 -1362 62 C16 1864 1210 3 S20 1215 -1864 23 GND -1864 -1285 43 DB4 1864 -1238 63 S40 1864 1341 4 S19 -1864 1090 24 OSC<sub>1</sub> -1864 -1414 44 DB5 1864 -1112 64 S39 1864 1466 5 S18 -1864965 25 OSC<sub>2</sub> -1120 -1754 45 DB6 1864 -988 65 S38 886 1754 6 S17 -1864 840 V1 -970 -1754 46 DB7 1864 -862 S37 760 1754 26 7 **S16** 27 V2 -820 -1754 47 C1 1864 S36 -1864 715 -665 67 636 1754 8 S15 -1864 590 28 V3 -670 -1754 48 C2 1864 -540 S35 510 1754 68 9 S14 V4 C3 -1864 465 29 -520 -1754 49 1864 -415 69 S34 386 1754 10 S13 -1864 340 30 V5 -370 -1754 50 C4 1864 -290 70 S33 260 1754 S12 CLK1 71 11 -1864 215 31 -220 -1754 51 C5 1864 -165 S32 136 1754 12 S11 -1864 90 32 CLK2 -70 -1754 52 C6 1864 -40 72 S31 10 1754 S10 **VDD** 13 -1864 -35 33 80 -1754 53 C7 1864 85 73 S30 -114 1754 14 S9 -1864 -160 34 230 -1754 54 C8 1864 210 74 S29 -240 1754 75 15 S8 -1864 -285 35 D 380 -1754 55 C9 1864 335 S28 -364 1754 16 S7 -1864 -410 36 RS 518 -1754 56 C10 1864 460 76 S27 -490 1754 S<sub>6</sub> -1864 37 R/W 642 -1754 C11 1864 -614 1754 17 -535 57 585 77 S26 18 S5 -1864-660 38 Ε 768 -1754 58 C12 1864 710 78 S25 -740 1754 C13 1864 19 S4 -1864 39 DB0 894 79 -864 1754 -785 -175459 835 S24 20 S3 -1864-910 40 DB1 1018 -1754 60 C14 1864 960 80 S23 -989 1754

# **PIN DESCRIPTION**

Table 2. Pin Description

Pin	Pin No.	I/O	Name	Description	Interface		
VDD	33	-	Supply Voltage	Supply Voltage for logical circuit (+3V ± 10%,+5V ± 10%)	Power Supply		
GND	23			Ground (0V)			
V1-V5	26-30			Bias voltage level for LCD driving			
S1-S40	1-22, 63-80			Segment signal output for LCD drive	LCD		
C1-C16	1-C16 47-62 O		Common output	Common signal output for LCD drive	LCD		
OSC1	24	ı	Oscillator	Oscillator. When using internal oscillator,	External		
OSC2	25	0	Oscillator	connect external Rf resistor.  If external clock is used, connect it to OSC1.	resistor/oscillator (OSC1)		
CLK1	31	0	Extension driver Latch clock	Extension driver latch clock	Extension driver		
CLK2	32	0	Extension driver Shift clock	Extension driver shift clock			
М	34	0	Alternated signal for LCD driver output	Outputs the alternating signal to convert LCD driver waveform to AC.	Extension driver		
D	35	0	Display data interface	Outputs extension driver data (the 41st dot's data)	Extension driver		
RS	36	I	Register select	Used as register selection input. When RS = 'High", Data register is selected. When RS = 'Low", Instruction register is selected.	MPU		
R/W	37	I	Read/Write	Used as read/write selection input. When RW = 'High", read operation. When RW = 'Low", write operation.	MPU		
E	38	I	Read/Write enable	Used as read/write enable signal.	MPU		
DB0-DB3	39-42	I/O	Data bus 0-7	In 8-bit bus mode, used as low order bidirectional data bus. In 4-bit bus mode, open these pins.	MPU		
DB4-DB7	43-46			In 8-bit bus mode, used as high order bidirectional data bus. In 4-bit bus mode, used as both high and low order. DB7 used for Busy Flag output.	MPU		



### **FUNCTION DESCRIPTION**

### **System Interface**

This chip has both kinds of interface type with MPU: 4-bit bus and 8-bit bus. 4-bit bus and 8-bit bus are selected by the DL bit in the instruction register.

During read or write operation, two 8-bit registers are used.

One is the data register (DR), and the other is the instruction register (IR).

The data register (DR) is used as a temporary data storage place for being written into or read from DDRAM/CGRAM. The target RAM is selected by RAM address setting instruction.

Each internal operation, reading from or writing into RAM, is done automatically.

Thus, after MPU reads DR data, the data in the next DDRAM/CGRAM address is transferred into DR automatically. Also, after MPU writes data to DR, the data in DR is transferred into DDRAM/CGRAM automatically.

The Instruction register(IR) is used only to store instruction codes transferred from MPU. MPU cannot use it to read instruction data.

To select a register, you can use RS input pin in 4-bit/8-bit bus mode.

Table 3. Various kinds of Operations according to RS and R/W bits

RS	R/W	Operation
L	L	Instruction Write operation (MPU writes Instruction code into IR)
L	Н	Read Busy flag(DB7) and address counter (DB0 to DB6)
Н	L	Data Write operation (MPU writes data into DR)
Н	Н	Data Read operation (MPU reads data from DR)

### **Busy Flag (BF)**

BF = 'High", indicates that the internal operation is being processed. So during this time the next instruction cannot be accepted. BF can be read through DB7 port when RS = 'Low" and R/W = 'High" (Read Instruction Operation). Before executing the next instruction, be sure that BF is not 'High".

### Address Counter (AC)

The address Counter (AC) stores DDRAM/CGRAM addresses, transferred from IR. After writing into (reading from) DDRAM/CGRAM, AC is automatically increased (decreased) by 1. When RS = 'Low" and R/W = 'High", AC can be read through ports DB0 to DB6.



# **Display Data RAM (DDRAM)**

DDRAM stores display data of maximum 80×8 bits (80 characters).

DDRAM address is set in the address counter(AC) as a hexadecimal number (Refer to Fig-1.)

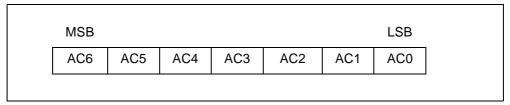


Figure 1 . DDRAM Address

#### 1) 1-line display

In case of 1-line display, the address range of DDRAM is 00H–4FH. An extension driver will be used. Fig-2 shows the example with 40 segment extension driver added.

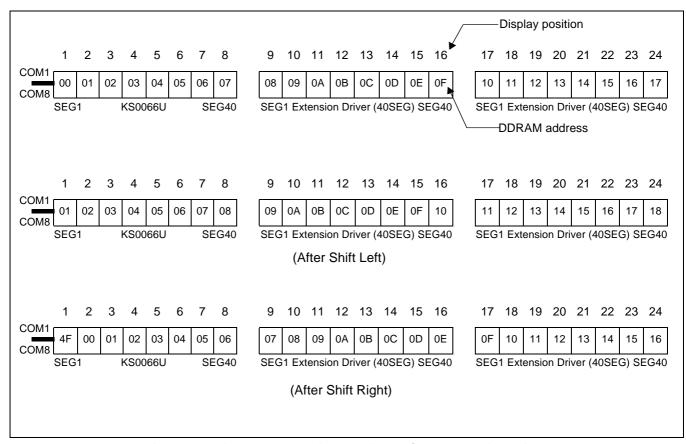


Figure 2 . 1-line ' 24 char. display with 40 SEG. extension driver



### 2) 2-line display

In case of 2-line display, the address range of DDRAM is 00H–27H and 40H–67H. An extension driver will be used. Fig-3 shows the example with 40 segment extension driver added.

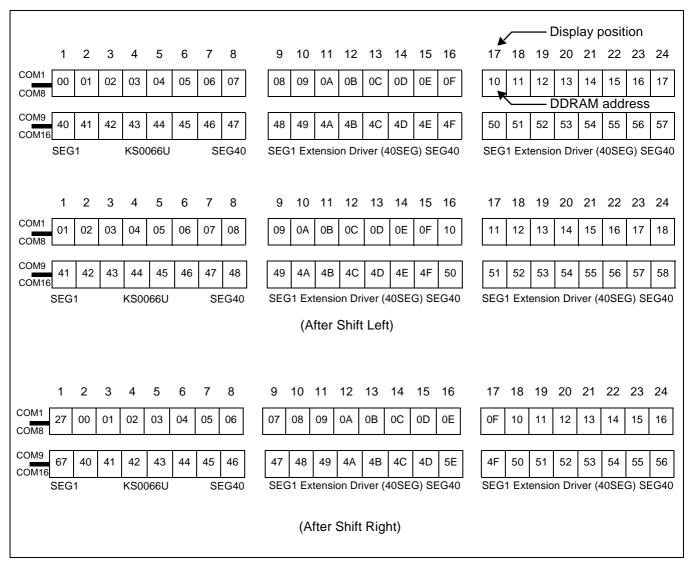


Figure 3. 2-line '24 char. display with 40 SEG. extension driver



# **CGROM(Character Generator ROM)**

CGROM has a  $5\times8$  dots 204 characters pattern and a  $5\times11$  dots 32 characters pattern (Refer to Table 4). CGROM has 204 character patterns of  $5\times8$  dots, and 32 character patterns of  $5\times11$  dots.

## **CGRAM(Character Generator RAM)**

CGRAM has up to 5×8 dots 8 characters. By writing font data to CGRAM, user defined characters can be used (Refer to Table 5)

### **Timing Generation Circuit**

Timing generation circuit generates clock signals for the internal operations.

### **LCD Driver Circuit**

LCD Driver circuit has 16 common and 40 segment signals for LCD driving.

Data from CGRAM/CGROM is transferred to a 40-bit segment latch serially, and then is stored to 40-bit shift latch. When each common is selected by 16-bit common register, segment data is also output through segment driver from a 40-bit segment latch.

In case of 1-line display mode, COM1 to COM8 have 1/8 duty or COM1 to COM11 have 1/11 duty, and in 2-line mode, COM1 to COM16 have a 1/16 duty ratio.

### **Cursor/Blink Control Circuit**

It controls the cursor/blink ON/OFF at cursor position.



**Table 4. CGROM Character Code Table** 



Table 5. Relationship between Character Code (DDRAM) and Character Pattern (CGRAM)

Ch	Character Code (DDRAM data)			ıta)	CGRAM Address			CGRAM Data						Pattern								
D7	D6	D5	D4	D3	D2	D1	D0	A5	<b>A4</b>	А3	<b>A2</b>	<b>A</b> 1	Α0	Р7	P6	P5	P4	Р3	P2	P1	P0	number
0	0	0	0	×	0	0	0	0	0	0	0	0	0	×	×	×	0	1	1	1	0	pattern 1
											0	0	1				1	0	0	0	1	
											0	1	0				1	0	0	0	1	
											0	1	1				1	1	1	1	1	
											1	0	0				1	0	0	0	1	
											1	0	1				1	0	0	0	1	
			•						•		1	1	0		•		1	0	0	0	1	
											1	1	1				0	0	0	0	0	
			-							_							<u>.</u>					· ·
										,								:				
0	0	0	0	×	1	1	1	0	0	0	0	0	0	×	×	×	1	0	0	0	1	pattern 8
											0	0	1				1	0	0	0	1	
											0	1	0				1	0	0	0	1	
									•		0	1	1				1	1	1	1	1	
									:		1	0	0				1	0	0	0	1	
			•						٠		1	0	1		•		1	0	0	0	1	
											1	1	0				1	0	0	0	1	
											1	1	1				0	0	0	0	0	

### INSTRUCTION DESCRIPTION

#### **Outline**

To overcome the speed difference between the internal clock of KS0066U and the MPU clock, KS0066U performs internal operations by storing control informations to IR or DR. The internal operation is determined according to the signal from MPU, composed of read/write and data bus (Refer to Table 7). Instructions can be divided largely into four groups:

- 1) KS0066U function set instructions (set display methods, set data length, etc.)
- 2) address set instructions to internal RAM
- 3) data transfer instructions with internal RAM
- 4) others

The address of the internal RAM is automatically increased or decreased by 1.

Note: During internal operation, Busy Flag (DB7) is read 'High'.

Busy Flag check must be preceded by the next instruction.

When an MPU program with checking the Busy Flag (DB7) is made, it must be necessary 1/2 fosc for executing the next instruction by the falling edge of the 'E' signal after the Busy Flag (DB7) goes to 'Low".

#### **Contents**

## 1) Clear Display

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	0	1

Clear all the display data by writing '20H" (space code) to all DDRAM address, and set DDRAM address to '00H" into AC (address counter).

Return cursor to the original status, namely, bring the cursor to the left edge on the first line of the display. Make the entry mode increment (I/D = High).

# 2) Return Home

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	1	-

\* "- ": dont care

Return Home is cursor return home instruction.

Set DDRAM address to '00H" into the address counter.

Return cursor to its original site and return display to its original status, if shifted.

Contents of DDRAM does not change.



### 3) Entry Mode Set

								DB1	
0	0	0	0	0	0	0	1	I/D	SH

Set the moving direction of cursor and display.

# I/D: Increment / decrement of DDRAM address (cursor or blink)

When I/D = 'High", cursor/blink moves to right and DDRAM address is increased by 1.

When I/D = 'Low', cursor/blink moves to left and DDRAM address is decreased by 1.

\* CGRAM operates the same way as DDRAM, when reading from or writing to CGRAM.

### SH: Shift of entire display

When DDRAM read (CGRAM read/write) operation or SH = 'Low", shifting of entire display is not performed. If SH = 'High" and DDRAM write operation, shift of entire display is performed according to I/D value (I/D = 'High": shift left, I/D = 'Low": shift right).

## 4) Display ON/OFF Control

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	1	D	С	В

Control display/cursor/blink ON/OFF 1 bit register.

#### D: Display ON/OFF control bit

When D = 'High", entire display is turned on.

When D = 'Low", display is turned off, but display data remains in DDRAM.

## C: Cursor ON/OFF control bit

When C ='High", cursor is turned on.

When C = 'Low", cursor is disappeared in current display, but I/D register preserves its data.

### **B: Cursor Blink ON/OFF control bit**

When B = 'High", cursor blink is on, which performs alternately between all the 'High" data and display characters at the cursor position.

When B = 'Low', blink is off.



# 5) Cursor or Display Shift

					DB4				
0	0	0	0	0	1	S/C	R/L	-	-

Shifting of right/left cursor position or display without writing or reading of display data.

This instruction is used to correct or search display data.(Refer to Table 6)

During 2-line mode display, cursor moves to the 2nd line after the 40th digit of the 1st line.

Note that display shift is performed simultaneously in all the lines.

When displayed data is shifted repeatedly, each line is shifted individually.

When display shift is performed, the contents of the address counter are not changed.

### Table 6. Shift Patterns According to S/C and R/L Bits

S/C	R/L	Operation
0	0	Shift cursor to the left, AC is decreased by 1
0	1	Shift cursor to the right, AC is increased by 1
1	0	Shift all the display to the left, cursor moves according to the display
1	1	Shift all the display to the right, cursor moves according to the display

## 6) Function Set

					DB4				
0	0	0	0	1	DL	N	F	-	-

### DL: Interface data length control bit

When DL = 'High", it means 8-bit bus mode with MPU.

When DL = 'Low", it means 4-bit bus mode with MPU. Hence, DL is a signal to select 8-bit or 4-bit bus mode.

When 4-bit bus mode, it needs to transfer 4-bit data twice.

### N: Display line number control bit

When N = 'Low", 1-line display mode is set.

When N = 'High", 2-line display mode is set.

# F: Display font type control bit

When F = `Low'',  $5 \times 8$  dots format display mode is set.

When F = High,  $5 \times 11$  dots format display mode.



# 7) Set CGRAM Address

					DB4					
0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	

### Set CGRAM address to AC.

This instruction makes CGRAM data available from MPU.

## 8) Set DDRAM Address

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0

### Set DDRAM address to AC.

This instruction makes DDRAM data available from MPU.

When 1-line display mode (N = Low), DDRAM address is from '00H" to "4FH".

In 2-line display mode (N = High), DDRAM address in the 1st line is from '00H" to '27H", and DDRAM address in the 2nd line is from '40H" to '67H".

### 9) Read Busy Flag & Address

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0

This instruction shows whether KS0066U is in internal operation or not.

If the resultant BF is 'High", internal operation is in progress and should wait until BF is to be Low, which by then the next instruction can be performed. In this instruction you can also read the value of the address counter.



### 10) Write data to RAM

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	D7	D6	D5	D4	D3	D2	D1	D0

Write binary 8-bit data to DDRAM/CGRAM.

The selection of RAM from DDRAM, and CGRAM, is set by the previous address set instruction (DRAM address set, CGRAM address set).

RAM set instruction can also determine the AC direction to RAM.

After write operation, the address is automatically increased/decreased by 1, according to the entry mode.

### 11) Read data from RAM

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D7	D6	D5	D4	D3	D2	D1	D0

### Read binary 8-bit data from DDRAM/CGRAM.

The selection of RAM is set by the previous address set instruction. If the address set instruction of RAM is not performed before this instruction, the data that has been read first is invalid, as the direction of AC is not Yet determined. If RAM data is read several times without RAM address instructions set before read operation, the correct RAM data can be obtained from the second. But the first data would be incorrect, as there is no time margin to transfer RAM data.

In case of DDRAM read operation, cursor shift instruction plays the same role as DDRAM address set instruction, it also transfers RAM data to output data register.

After read operation, address counter is automatically increased/decreased by 1 according to the entry mode. After CGRAM read operation, display shift may not be executed correctly.

NOTE: In case of RAM write operation, AC is increased/decreased by 1 as in read operation.

At this time, AC indicates the next address position, but only the previous data can be read by the read

At this time, AC indicates the next address position, but only the previous data can be read by the read instruction.



**Table 7. Instruction Table** 

Instruction		Instruction Code									Description	Execution time (fosc=
instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	270 kHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write '20H" to DDRAM and set DDRAM address to '00H" from AC	1.53 ms
Return Home	0	0	0	0	0	0	0	0	1	Set DDRAM address to '00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.		1.53 ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	39 μs
Display ON/ OFF Control	0	0	0	0	0	0	1	D	С	В	Set display(D), cursor(C), and blinking of cursor(B) on/off control bit.	39 μs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	-	-	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 μs
Function Set	0	0	0	0	1	DL	N	F	-	-	Set interface data length (DL: 8-bit/4-bit), numbers of display line (N: 2-line/1-line) and, display font type (F:5×11dots/5×8 dots)	39 μs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 μs
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	39 μs
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μs
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43 μs
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43 μs

\* "-": dont care

NOTE: When an MPU program with checking the Busy Flag(DB7) is made, it must be necessary 1/2Fosc is necessary for executing the next instruction by the falling edge of the 'E' signal after the Busy Flag (DB7) goes to 'Low".



# **INTERFACE WITH MPU**

#### 1) Interface with 8-bit MPU

When interfacing data length are 8-bit, transfer is performed at a time through 8 ports, from DB0 to DB7. Example of timing sequence is shown below.

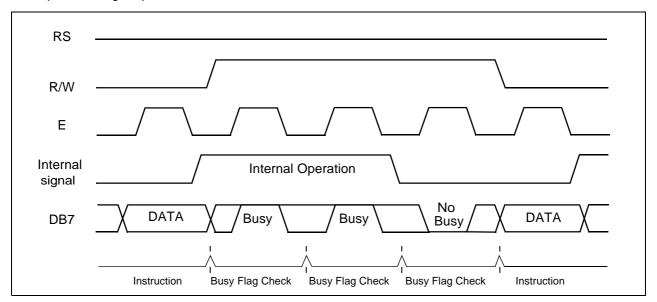


Figure 4. Example of 8-bit Bus Mode Timing Diagram

### 2) Interface with 4-bit MPU

When interfacing data length are 4-bit, only 4 ports, from DB4 to DB7, are used as data bus. At First, the higher 4-bit (in case of 8-bit bus mode, the contents of DB4 - DB7), and then the lower 4-bit (in case of 8-bit bus mode, the contents of DB0 - DB3) are transferred. So transfer is performed twice Busy Flag outputs 'High" after the second transfer is ended. Example of timing sequence is shown below.

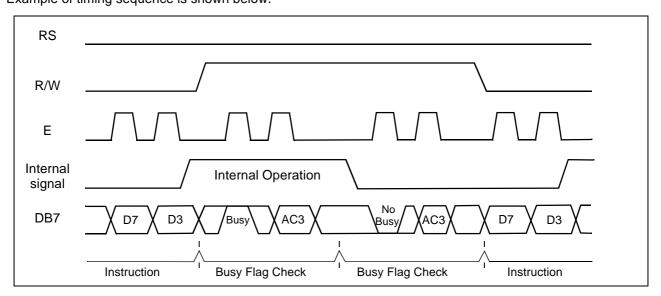
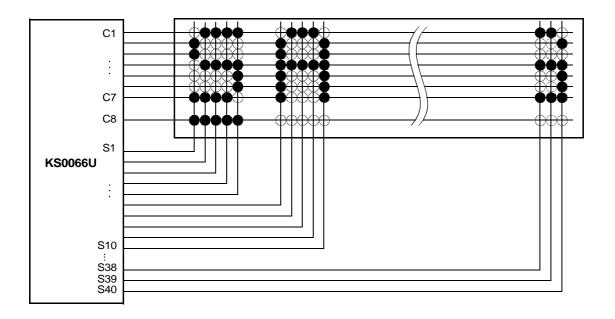


Figure 5. Example of 4-bit Bus Mode Timing Diagram

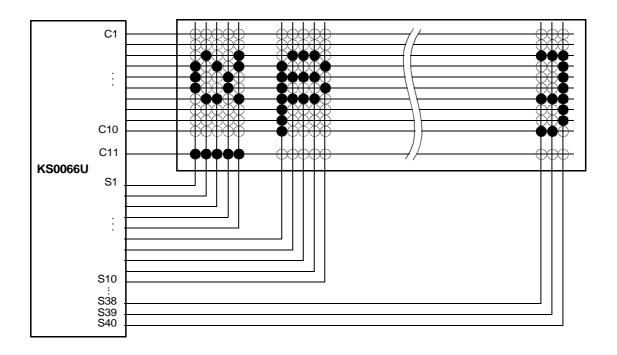


# APPLICATION INFORMATION ACCORDING TO LCD PANEL

1) LCD Panel: 8 characters ×1-line format (5×7 dots + 1 cursor line, 1/4 bias, 1/8 duty)

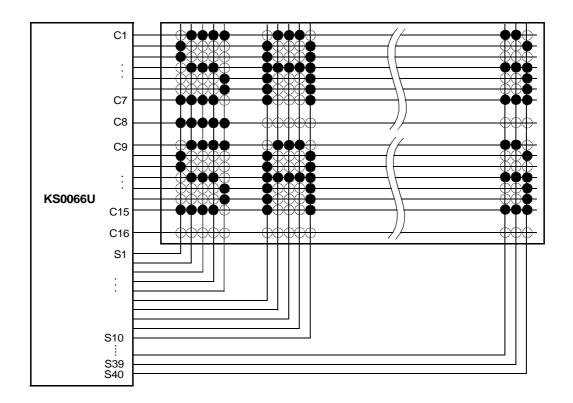


2) LCD Panel: 8 characters ×1-line format (5×10 dots + 1 cursor line, 1/4 bias, 1/11 duty)

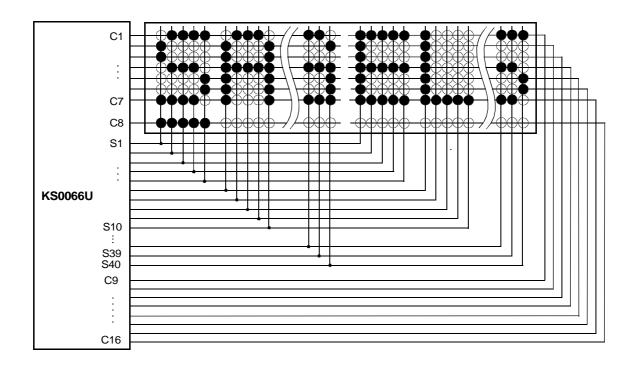




3) LCD Panel: 8 characters ×2 -line format (5×7 dots + line, 1/5 bias, 1/16 duty)

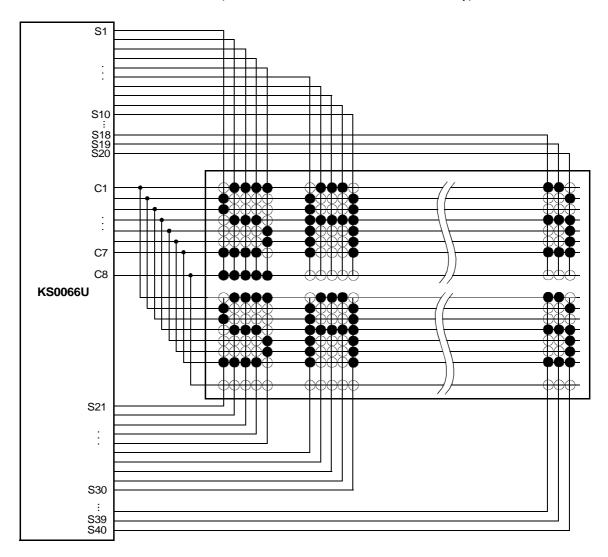


4) LCD Panel: 16 characters ×1-line format (5×7 dots + 1 cursor line, 1/5 bias, 1/16 duty)

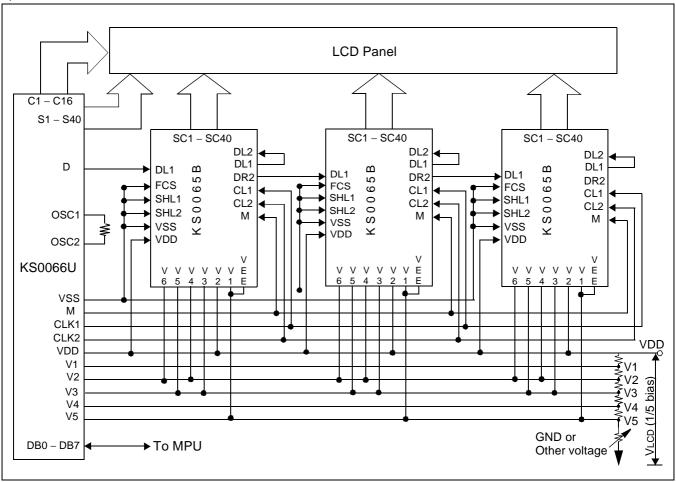




5) LCD Panel: 4 characters ×2-line format (5×7 dots + 1cursor line, 1/4 bias, 1/8 duty)



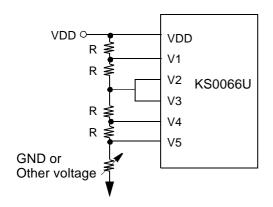
# 6) APPLICATION CIRCUIT



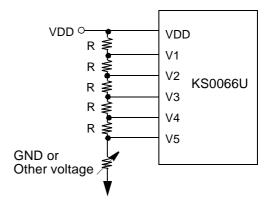
NOTE: When KS0065B is externally connected to the KS0066U, you can increase the number of display digits up to 80 characters.

# **BIAS VOLTAGE DIVIDE CIRCUIT**

1) 1/4 bias, 1/8 or 1/11 duty



### 2) 1/5 bias, 1/16 duty





### **INITIALIZING**

When the power is turned on, KS0066U is initialized automatically by power on reset circuit.

During the initialization, the following instructions are executed, and BF (Busy Flag) is kept 'High" (busy state) to the end of initialization.

- (1) Display Clear instruction: Write "20H" to all DDRAM
- (2) Set Functions instruction: DL = 'High'': 8-bit bus mode

N = 'Low': 1-line display mode

F = "Low": 5 X 8 font type

(3) Control Display ON/OFF instruction: D = 'Low': Display OFF

C = "Low": Cursor OFF

B = 'Low": Blink OFF

(4) Set Entry Mode instruction: I/D = 'High". Increment by 1

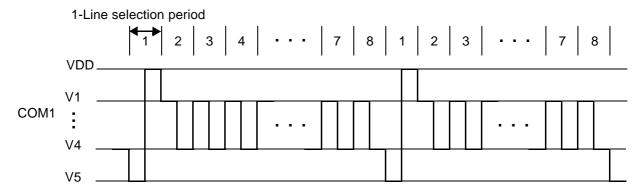
SH = 'Low'. No entire display shift

### FRAME FREQUENCY

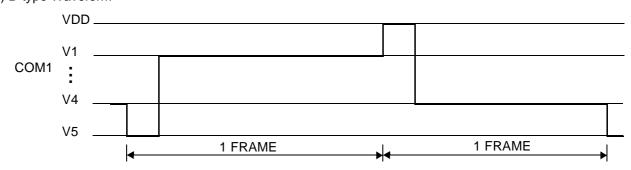
Programmable Driving Method by the same font mask option: Display waveform A-Type, B-Type

# 1) 1/8 duty cycle

# A) A-type Waveform



# B) B-type Waveform



1-Line selection period = 400 clocks

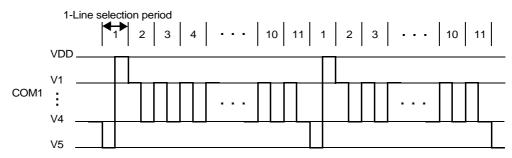
1 Frame =  $400 \times 8 \times 3.7 \,\mu s = 11850 \,\mu s = 11.9 \,ms$  (1 clock=3.7  $\mu s$ , fosc=270 kHz)

Frame frequency = 1/11.9 ms = 84.4 Hz

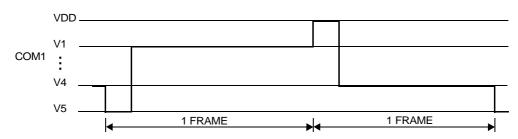


# 2) 1/11 duty cycle

### A) A-type Waveform



# B) B-type Waveform



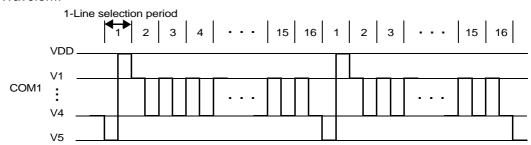
1-Line selection period = 400 clocks

1 Frame =  $400 \times 11 \times 3.7 \,\mu s$  =  $16300 \,\mu s$  =  $16.3 \,ms$  (1 clock= $3.7 \,\mu s$ , fosc= $270 \,kHz$ )

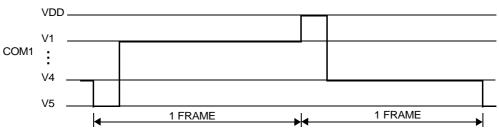
Frame frequency = 1 / 16.3 ms = 61.4 Hz

# 3) 1/16 duty cycle

## A) A-type Waveform



# B) B-type Waveform



1-Line selection period = 200 clocks

=  $200 \times 16 \times 3.7 \,\mu s$  =  $11850 \,\mu s$  =  $11.9 \,ms$  (1 clock= $3.7 \,\mu s$ , fosc= $270 \,kHz$ ) 1 Frame

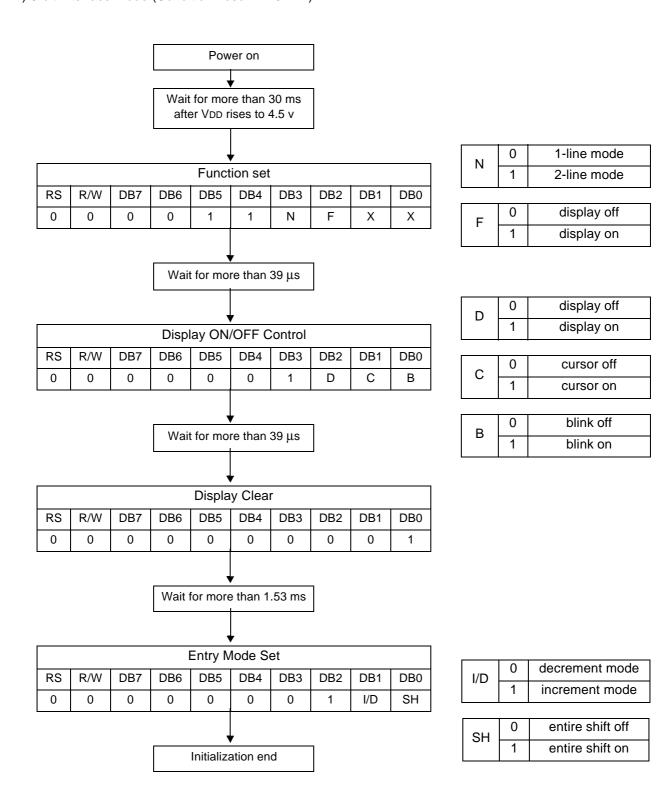
Frame frequency = 1 / 11.9 ms = 84.3 Hz



**ELECTRONICS** 

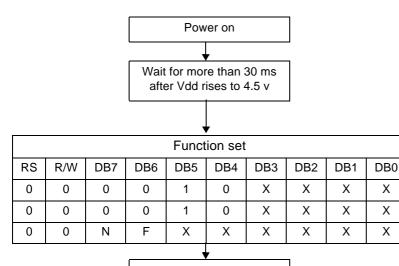
### **INITIALIZING BY INSTRUCTION**

1) 8-bit interface mode (Condition: fosc = 270KHZ)





# 2) 4-bit interface mode (Condition: fosc = 270KHZ)



N	0	1-line mode
IN	1	2-line mode

F	0	display off
•	1	display on

Wait for mo	re than 39 μs

	Display ON/OFF Control											
RS	RS R/W DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0											
0	0	0	0	0	0	Х	Х	Х	Х			
0	0 0 1 D C B X X X X											

D	0	display off
D	1	display on

С	C	cursor off
Ü	1	cursor on

В	0	blink off
	1	blink on

Wait for more than 39 μs

	Display Clear									
RS R/W DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0									DB0	
0	0	0	0	0	0	Х	Х	Х	Х	
0	0	0	0	0	1	Х	Х	Х	Х	

Wait for more than 1.53 ms

				'	/				
	Entry Mode Set								
RS R/W DB7 DB6 DB5 DB4 DB3 DB2 DB1 DE								DB0	
0	0	0	0	0	0	Х	Х	Х	Х
0	0	0	1	I/D	SH	Х	Х	Х	Х
Initialization end									

I/D	0	decrement mode
1/0	1	increment mode

SH	0	entire shift off
0	1	entire shift on

# **MAXIMUM ABSOLUTE LIMIT**

**Table 8. Maximum Absolute Power Ratings** 

Characteristic	Symbol	Unit	Value
Power Supply Voltage(1)	$V_{DD}$	V	-0.3 ~ +7.0
Power Supply Voltage(2)	V <sub>LCD</sub>	V	V <sub>DD</sub> -15.0 ~ V <sub>DD</sub> +0.3
Input Voltage	V <sub>IN</sub>	V	-0.3 ~ V <sub>DD</sub> +0.3

NOTE: Voltage greater than above may damage the circuit.

 $V_{DD} \ge V1 \ge V2 \ge V3 \ge V4 \ge V5$ 

Table 9. Temperature characteristics

Characteristic	Symbol	Unit	Value
Operating Temperature	Topr	°C	-30 ~ +85
Storage Temperature	Тѕтс	°C	-55 ~ +125

# **ELECTRICAL CHARACTERISTICS**

### **DC Characteristics**

Table 10. DC Characteristics ( $V_{DD} = 4.5V \sim 5.5V$ , Ta = -30  $\sim +85^{\circ}C$ )

Characteristic	Symbol	Condition	Min.	Тур.	Max.	Unit	
Operating Voltage	V <sub>DD</sub>	-	4.5	-	5.5	V	
Supply Current	I <sub>DD</sub>	Internal oscillation or external clock. (V <sub>DD</sub> =5.0 V, fosc = 270 kHz)	-	0.35	0.6	mA	
Input Voltage (1)	V <sub>IH1</sub>	-	2.2	-	$V_{DD}$	V	
(except OSC1)	V <sub>IL1</sub>	-	-0.3	-	0.6	V	
Input Voltage (2)	V <sub>IH2</sub>	-	V <sub>DD</sub> -1.0	-	$V_{DD}$	V	
(OSC1)	V <sub>IL2</sub>	-	-0.2	-	1.0	V	
Output Voltage (1)	V <sub>OH1</sub>	I <sub>OH</sub> = -0.205 mA	2.4	-	-	V	
(DB0 to DB7)	V <sub>OL1</sub>	I <sub>OL</sub> = 1.2 mA	-	-	0.4		
Output Voltage (2) (except DB0 to DB7)	V <sub>OH2</sub>	I <sub>O</sub> = -40 μA	0.9V <sub>DD</sub>	-	-	V	
	V <sub>OL2</sub>	Ι <sub>Ο</sub> = 40 μΑ	-	-	0.1V <sub>DD</sub>	V	
Voltage Drop	Vd <sub>COM</sub>	$I_{O} = \pm 0.1 \text{ mA}$	-	-	1	V	
voltage Diop	Vd <sub>SEG</sub>	10 – ± 0.1 mA	-	- 0.1V <sub>D</sub>	1	V	
Input Leakage Current	I <sub>IKG</sub>	$V_{IN} = 0 \text{ V to } V_{DD}$	-1	-	1		
Input Low Current	I <sub>IL</sub>	V <sub>IN</sub> = 0 V, V <sub>DD</sub> = 5 V (PULL UP)	-50	-125	-250	μΑ	
Internal Clock (external Rf)	f <sub>OSC1</sub>	Rf = 91 k $\Omega$ <u>+</u> 2% (V <sub>DD</sub> = 5 V)	190	270	350	kHz	
	f <sub>OSC</sub>		125	270	410	kHz	
External Clock	duty	-	45	50	55	%	
	t <sub>R</sub> , t <sub>F</sub>		-	-	0.2	μs	
LCD Driving Voltage	V <sub>LCD</sub>	V <sub>DD</sub> -V <sub>5</sub> (1/5, 1/4 Bias)	3.0	-	13.0	V	



Table 11. DC Characteristic ( $V_{DD}$  =2.7V ~ 4.5V, Ta = -30 ~ +85°C)

Characteristic	Symbol	Condition	Min.	Тур.	Max.	Unit
Operating Voltage	$V_{DD}$	-	2.7	-	4.5	V
Supply Current	I <sub>DD</sub>	Internal oscillation or external clock. (V <sub>DD</sub> =3.0 V, fosc = 270 kHz)	-	0.15	0.3	mA
Input Voltage (1)	V <sub>IH1</sub>	-	0.7V <sub>DD</sub>	-	$V_{DD}$	V
(except OSC1)	V <sub>IL1</sub>	-	-0.3	-	0.55	V
Input Voltage (2)	V <sub>IH2</sub>	-	0.7V <sub>DD</sub>	-	$V_{DD}$	V
(OSC1)	V <sub>IL2</sub>	-	-	-	0.2V <sub>DD</sub>	V
Output Voltage (1)	V <sub>OH1</sub>	I <sub>OH</sub> = -0.1 mA	0.75V <sub>DD</sub>	-	-	V
(DB0 to DB7)	V <sub>OL1</sub>	I <sub>OL</sub> = 0.1 mA	-	-	0.2V <sub>DD</sub>	V
Output Voltage (2) (except DB0 to DB7)	V <sub>OH2</sub>	I <sub>O</sub> = -40 μA	0.8V <sub>DD</sub>	-	-	٧
	V <sub>OL2</sub>	I <sub>O</sub> = 40 μA	-	-	0.2V <sub>DD</sub>	
Voltage Drop	Vd <sub>COM</sub>	$I_{O} = \pm 0.1 \text{ mA}$	-	- 0.2V <sub>DD</sub>	1	V
Voltage Drop	Vd <sub>SEG</sub>	10 - ± 0.1 IIIA	-	-	1	V
Input Leakage Current	I <sub>IKG</sub>	$V_{IN} = 0 V \text{ to } V_{DD}$	-1	-	1	
Input Low Current	I <sub>IL</sub>	V <sub>IN</sub> = 0 V, V <sub>DD</sub> = 3 V (PULL UP)	-10	-50	-120	μΑ
Internal Clock (external Rf)	f <sub>OSC1</sub>	Rf = 75 k $\Omega$ ± 2% (V <sub>DD</sub> = 3 V)	190	270	350	kHz
	f <sub>OSC2</sub>		125	270	410	kHz
External Clock	duty	-	45	50	55	%
	t <sub>R</sub> ,t <sub>F</sub>		-	-	0.2	μs
LCD Driving Voltage	$V_{LCD}$	V <sub>DD</sub> -V <sub>5</sub> (1/5, 1/4 Bias)	3.0	-	13.0	V

NOTE: LCD Driving Voltage

Power	Duty	1/8, 1/11 Duty	1/16 Duty
rowei	Bias	Bias         1/4 Bias         1/5 Bias           V <sub>DD</sub> V <sub>DD</sub> V <sub>DD</sub> -V <sub>LCD</sub> /4         V <sub>DD</sub> -V <sub>LCD</sub> /5           V <sub>DD</sub> -V <sub>LCD</sub> /2         V <sub>DD</sub> -2V <sub>LCD</sub> /5           V <sub>DD</sub> -V <sub>LCD</sub> /2         V <sub>DD</sub> -3V <sub>LCD</sub> /5           V <sub>DD</sub> -3V <sub>LCD</sub> /4         V <sub>DD</sub> -4V <sub>LCD</sub> /5	
	$V_{DD}$	V <sub>DD</sub>	V <sub>DD</sub>
	V <sub>1</sub>	V <sub>DD</sub> -V <sub>LCD</sub> /4	V <sub>DD</sub> -V <sub>LCD</sub> /5
	V <sub>2</sub>	V <sub>DD</sub> -V <sub>LCD</sub> /2	V <sub>DD</sub> -2V <sub>LCD</sub> /5
	V <sub>3</sub>	V <sub>DD</sub> -V <sub>LCD</sub> /2	V <sub>DD</sub> -3V <sub>LCD</sub> /5
	V <sub>4</sub>	V <sub>DD</sub> -3V <sub>LCD</sub> /4	V <sub>DD</sub> -4V <sub>LCD</sub> /5
	V <sub>5</sub>	V <sub>DD</sub> -V <sub>LCD</sub>	V <sub>DD</sub> -V <sub>LCD</sub>



# **AC Characteristics**

Table 12. AC Characteristics ( $V_{DD} = 4.5V \sim 5.5V$ , Ta = -30  $\sim +85^{\circ}C$ )

Mode	Characteristic	Symbol	Min.	Тур.	Max.	Unit
	E Cycle Time	tc	500	-	-	
	E Rise / Fall Time	t <sub>R</sub> ,t <sub>F</sub>	-	-	20	
Write Mode	E Pulse Width (High, Low)	tw	230	-	-	
Write Mode (Refer to Fig-6)	R/W and RS Setup Time	tsu1	40	-	-	ns
(Refer to Fig-6)	R/W and RS Hold Time	t <sub>H1</sub>	10	-	-	
	Data Setup Time	tsu2	80	-	-	
	Data Hold Time	t <sub>H2</sub>	10	-	-	
	E Cycle Time	tc	500	-	-	
	E Rise / Fall Time	t <sub>R</sub> ,t <sub>F</sub>	-	-	20	
	E Pulse Width (High, Low)	tw	230	-	-	
Read Mode	R/W and RS Setup Time	tsu	40	-	-	ns
(Refer to Fig-7)	R/W and RS Hold Time	t <sub>H</sub>	10	-	-	
	Data Output Delay Time	t <sub>D</sub>	-	-	120	
	Data Hold Time	t <sub>DH</sub>	5	-	-	

Table 13. AC Characteristics (V<sub>DD</sub> =2.7V  $\sim$  4.5V, Ta = -30  $\sim$  +85°C)

Mode	Characteristic	Symbol	Min.	Тур.	Max.	Unit
	E Cycle Time	tc	1000	-	-	
	E Rise / Fall Time	t <sub>R</sub> t <sub>F</sub>	-	-	25	
	E Pulse Width (High, Low)	tw	450	-	-	
Write Mode (Refer to Fig-6)	R/W and RS Setup Time	tsu1	60	-	-	ns
(refer to rig e)	R/W and RS Hold Time	t <sub>H1</sub>	20	-	-	
	Data Setup Time	tsu2	195	-	-	
	Data Hold Time	t <sub>H2</sub>	10	-	-	
	E Cycle Time	tc	1000	-	-	
	E Rise / Fall Time	t <sub>R</sub> ,t <sub>F</sub>	-	-	25	
	E Pulse Width (High, Low)	tw	450	-	-	
Read Mode	R/W and RS Setup Time	tsu	60	-	-	ns
(Refer to Fig-7)	R/W and RS Hold Time	t <sub>H</sub>	20	-	-	
	Data Output Delay Time	t <sub>D</sub>	-	-	360	
	Data Hold Time	t <sub>DH</sub>	5	-	-	



Mode	Characteristic	Symbol	Min.	Тур.	Max.	Unit
Interface Mode with	Clock Pulse Width (High, Low)	tc	800	-	-	
	Clock Rise / Fall Time	$t_R, t_F$	-	-	25	
	Clock Setup Time	tsu1	500	-	-	
Extension Driver	Data Setup Time	tsu2	300	-	-	ns
(Refer to Fig-8)	Data Hold Time	t <sub>DH</sub>	300	-	-	
	M Delay Time	t <sub>DM</sub>	-1000	-	1000	

Table 14. AC Characteristics ( $V_{DD}$  =2.7V ~ 4.5V, Ta = -30 ~ +85°C)

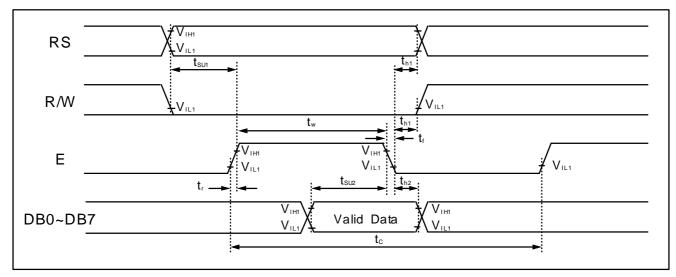


Figure 6. Write Mode Timing Diagram

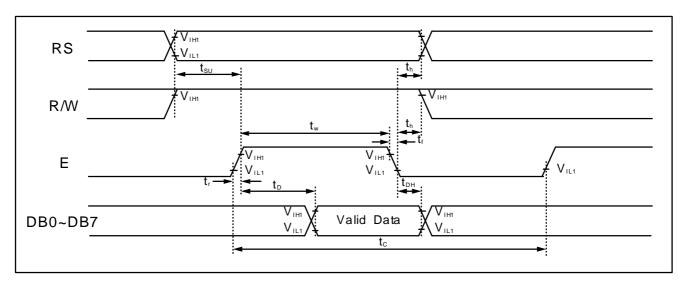


Figure 7. Read Mode Timing Diagram



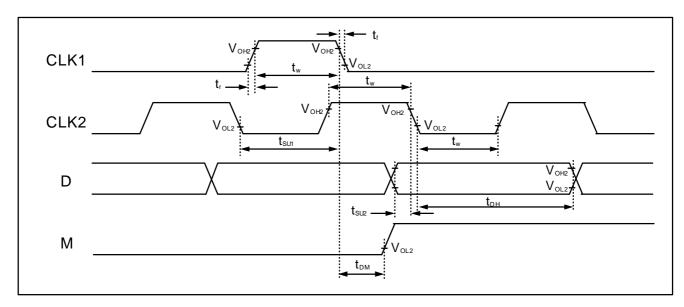


Figure 8 . Interface Mode With Extension Driver Timing Diagram

